

XENSIV™ TMR wheel speed sensor for magnetic encoder application

Features

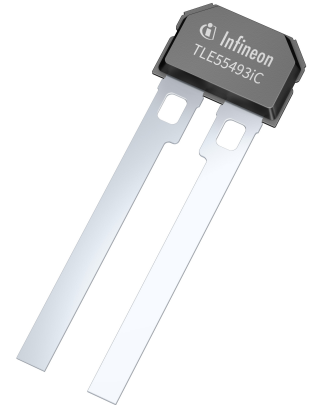
- High spatial resolution: 4 output protocols per magnetic period
- Valid and correct direction on first output protocol
- Enhanced digital algorithm ensures correct protocols even under mechanical vibration conditions
- Advanced stop-start capabilities including no loss of direction information
- Differential concept for robustness against external magnetic disturbance
- ISO 26262 safety element out of context for safety requirements up to ASIL D

Potential applications

- Anti-lock braking system
- Indirect tire pressure monitoring system
- Hill holder and electronic parking brake with high resolution
- Autonomous parking with high resolution

Product validation

Product validation according to AEC-Q100, Grade 0. Qualified for automotive applications.



Description

The TLE55493iC is a wheel speed sensor featuring high angular resolution and fast direction detection, designed for sophisticated vehicle control systems and autonomous parking applications.

The rotational speed is sensed with high accuracy for best in class jitter performance, enabling the sensor to be used as a component of indirect tire pressure monitoring systems (iTPMS). It is based on linearized TMR, providing a wide linear range and operating area. Thanks to the differential sensing principle, excellent robustness against external homogeneous magnetic field disturbances is achieved to support new requirements coming from electrification. Excellent sensitivity to magnetic field is specified over a wide temperature range to support a larger operating area. To meet harsh automotive requirements, robustness to electrostatic discharge (ESD) and electromagnetic compatibility (EMC) has been maximized without the need of additional external components.

Note

This document provides an extract of the full datasheet. A detailed version of the datasheet is available upon request through your Infineon regional representative.

Ordering information

| Name | Marking | Ordering Code | Package |
|------------------|---------|---------------|-------------|
| TLE55493iC-LR-4H | 493X6B | SP005904498 | PG-SSO-2-51 |

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1 Pin configuration and application circuit

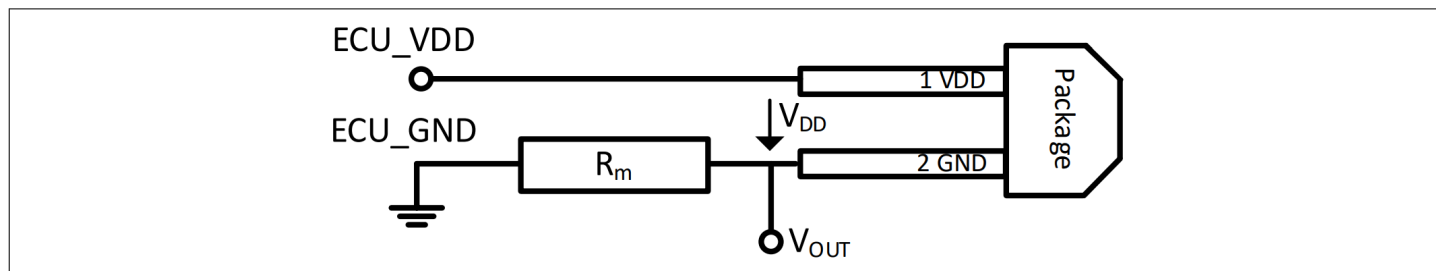


Figure 1 Application circuit example - load resistor (R_m) on GND pin

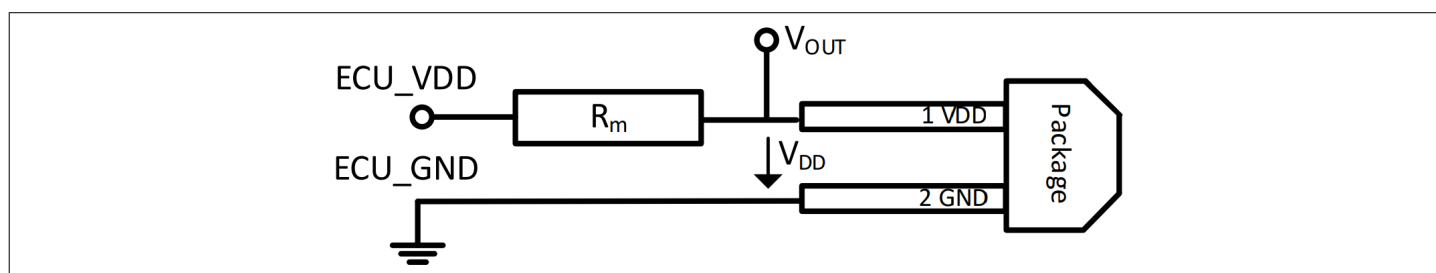


Figure 2 Application circuit example - load resistor (R_m) on V_{DD} pin

| Pin No. | Symbol | Function |
|---------|----------|----------------|
| 1 | V_{DD} | Supply voltage |
| 2 | GND | Ground |

2 Operating range

All parameters specified as parametric characteristics (see Table 2) refer to the below-listed operating conditions unless otherwise stated. The operating range does not specify technical requirements, but rather defines the boundary conditions of the requirements and their verification.

Table 1 Operating range

| Parameter | Symbol | Values | | | Unit | Note or condition |
|---|---------------|----------------|------|------|--------------------|--|
| | | Min. | Typ. | Max. | | |
| Electrical | | | | | | |
| Supply voltage | V_{DD} | $3.5+V_{HYST}$ | - | 20 | V | at sensor pins, $V_{HYST}=V_{DD_HYST}$ |
| Load resistor | R_m | 3 | - | 50 | Ω | - |
| Application temperature mission profile | | | | | | |
| Junction temperature | T_J | -40 | - | 110 | $^{\circ}\text{C}$ | either 12500 h |
| | | -40 | - | 170 | $^{\circ}\text{C}$ | or 500 h |
| | | -10 | - | 60 | $^{\circ}\text{C}$ | additional 30000 h (battery charging time) |
| Magnetical | | | | | | |
| Magnetic signal frequency range | f_{MAG} | 0 | - | 2500 | Hz | $f_{EL}=4 \cdot f_{MAG}$; Footnote ¹⁾ |
| Magnetic input signal at each sensing element | B_N | -29.1 | - | 29.1 | mT | $T_J = 25^{\circ}\text{C}$, $B_N = \sqrt{(B_X^2+B_Y^2)}$ |
| Differential input signal range in speed path | dB_{SP} | -60 | - | 60 | mT | $T_J = 25^{\circ}\text{C}$ |
| Differential input signal range in direction path | dB_{DR} | -20.0 | - | 20.0 | mT | $T_J = 25^{\circ}\text{C}$ |
| Limit threshold speed | dB_{LIMIT} | 135 | 180 | 225 | μT | $T_J = 25^{\circ}\text{C}$, Footnote ²⁾ ³⁾ |
| Static homogeneous external disturbance field | B_{EXT_DC} | -5 | - | 5 | mT | static field, same field at all sensing elements, Footnote ⁴⁾ |

1) Startup switching behavior to be considered especially at high speed.

2) Amplitude value, differential field.

3) No missing protocol while differential magnetic input is above max. dB_{LIMIT} . No protocol delivered while differential magnetic input is below min. dB_{LIMIT} . Verified with constant amplitude, constant offset and constant operating condition and at $f_{MAG} \geq 1\text{Hz}$.

4) Criterion: no additional/ missing protocols. Parametric characteristics valid only at typical value.

3 Parametric characteristics

The product characteristics are valid over the operating range. All values are specified for a sinusoidal signal with constant amplitude and offset, at constant operating conditions (i.e. wheel rotation direction, supply voltage, junction temperature). Typical values correspond to $V_{DD} = 12\text{ V}$ and $T_A = 25^\circ\text{C}$. Not all product characteristics are subject to production test, some are verified by design/characterization.

Table 2 Parametric characteristics

| Parameter | Symbol | Values | | | Unit | Note or condition |
|---|------------------|--------|------|------|-------------|--|
| | | Min. | Typ. | Max. | | |
| Period jitter on speed zero-crossing protocols | | | | | | |
| Period jitter on speed zero-crossing protocols | S_{JIT_ZC} | - | - | 0.15 | % | $dB_{SP} > 2 \cdot dB_{LIMIT}$, $\pm 1\sigma$ |
| Duty cycle of speed zero-crossing protocols | | | | | | |
| Duty cycle of speed zero-crossing protocols | DC_{ZC} | 45.0 | - | 55.0 | % | $dB_{SP} > 2 \cdot dB_{LIMIT}$, calibrated mode |
| Duty cycle variation on consecutive zero-crossing protocols | DC_{VAR_ZC} | - | 1 | 1.5 | % | $dB_{SP} > 2 \cdot dB_{LIMIT}$, calibrated mode, Footnote ¹⁾ |
| Period jitter on high-resolution protocols | | | | | | |
| Period jitter on high resolution protocols | S_{JIT_HR} | - | - | 0.80 | % | $dB_{SP} > 2 \cdot dB_{LIMIT}$, calibrated mode, $\pm 1\sigma$ |
| Duty cycle of high-resolution protocols | | | | | | |
| Duty cycle of high resolution protocols | DC_{HR} | 40.0 | - | 60.0 | % | $dB_{SP} > 2 \cdot dB_{LIMIT}$, calibrated mode |
| Duty cycle variation on consecutive high resolution protocols | DC_{VAR_HR} | - | 2 | 3 | % | $dB_{SP} > 2 \cdot dB_{LIMIT}$, $dB_{DR} > 2 \cdot dB_{LIMIT,DR}$ calibrated mode, Footnote ¹⁾ |
| Power-on and startup behavior | | | | | | |
| Protocols required to have valid direction | n_{DIR} | - | - | 0 | - | Footnote ^{2) 3)} |
| Electrical | | | | | | |
| Output current slew rate | SR_R SR_F | 11 | - | 28 | mA/ μ s | $SR_R = (I_{10\%} - I_{90\%}) / t_R$, $SR_F = (I_{90\%} - I_{10\%}) / t_F$, Footnote ⁴⁾ |
| Failure indication current | I_{ERR} | 0 | 2.2 | 3 | mA | Footnote ⁵⁾ |
| Output current during static output low state | I_{LOW} | 6.2 | 7 | 7.8 | mA | - |
| Output current during static output mid state | I_{MID} | 12.6 | 14 | 15.4 | mA | - |
| Output current during static output high state | I_{HIGH} | 25.4 | 28 | 30.6 | mA | - |

(table continues...)

3 Parametric characteristics

Table 2 (continued) Parametric characteristics

| Parameter | Symbol | Values | | | Unit | Note or condition |
|----------------------|----------------------|--------|------|------|-----------|---|
| | | Min. | Typ. | Max. | | |
| Supply current ratio | I_{MID} / I_{LOW} | 1.9 | - | 2.2 | - | same temperature and same R_M for both current levels |
| | I_{HIGH} / I_{LOW} | 3.8 | - | 4.5 | - | same temperature and same R_M for both current levels |
| Line regulation | G_L | - | - | 90 | $\mu A/V$ | dI/dV _{DD} , quasi static |
| Reset level | V_{DD_RESET} | - | - | 3.5 | V | - |
| Supply Hysteresis | V_{DD_HYST} | 1.5 | - | 1.7 | V | AK protocol |

Thermal

| | | | | | | |
|--------------------|----------|---|-----|-----|-----|---------------------------------------|
| Thermal resistance | R_{th} | - | 120 | 190 | K/W | junction-to-ambient, PG-SSO-2 package |
|--------------------|----------|---|-----|-----|-----|---------------------------------------|

- 1) Variation between consecutive duty cycle values. Absolute value.
- 2) 1st protocol delivers valid and correct direction information.
- 3) 2nd protocol delivers valid and correct direction information in case of a temperature watchdog event triggered by sensor self-heating (change of T_J).
- 4) Valid for any current level transition, for any resistor value in the valid range and no external capacitor.
- 5) I_{ERR} is a low current level implemented to signalize failures which might severely impact the sensor's functionality. For more details, please refer to the product-specific safety manual.

Table 3 Output protocol (AK)

| Parameter | Symbol | Values | | | Unit | Note or condition |
|-------------|--------|--------|------|------|---------|--------------------------------------|
| | | Min. | Typ. | Max. | | |
| AK bit time | t_P | 40 | 43 | 46 | μs | compliant with VDA 4.0 (AK protocol) |

Standstill period

| | | | | | | |
|--|-------------|-------|-----|-------|---------|------------------------|
| Standstill period | t_{STOP} | 127.5 | 150 | 172.5 | ms | - |
| Delay between magnetic event and output protocol | t_{DELAY} | 58 | 65 | 72 | μs | Footnote ¹⁾ |

- 1) Time between digital switching event (zero crossing or angle threshold) and rising edge of the first AK protocol pulse (t_P for bit stumpp + $t_P / 2$ for initial I_{LOW} state).

4 Functional description

The sensor features a magnetic sensing interface, which senses the magnetic field change generated by the movement of a magnetized encoder wheel, and detects its rotational direction. The sensing principle is based on linearized TMR, sensitive to the magnetic field in x-direction. In the following figure the typical placement of the TLE55493iC facing a magnetic encoder wheel is shown.

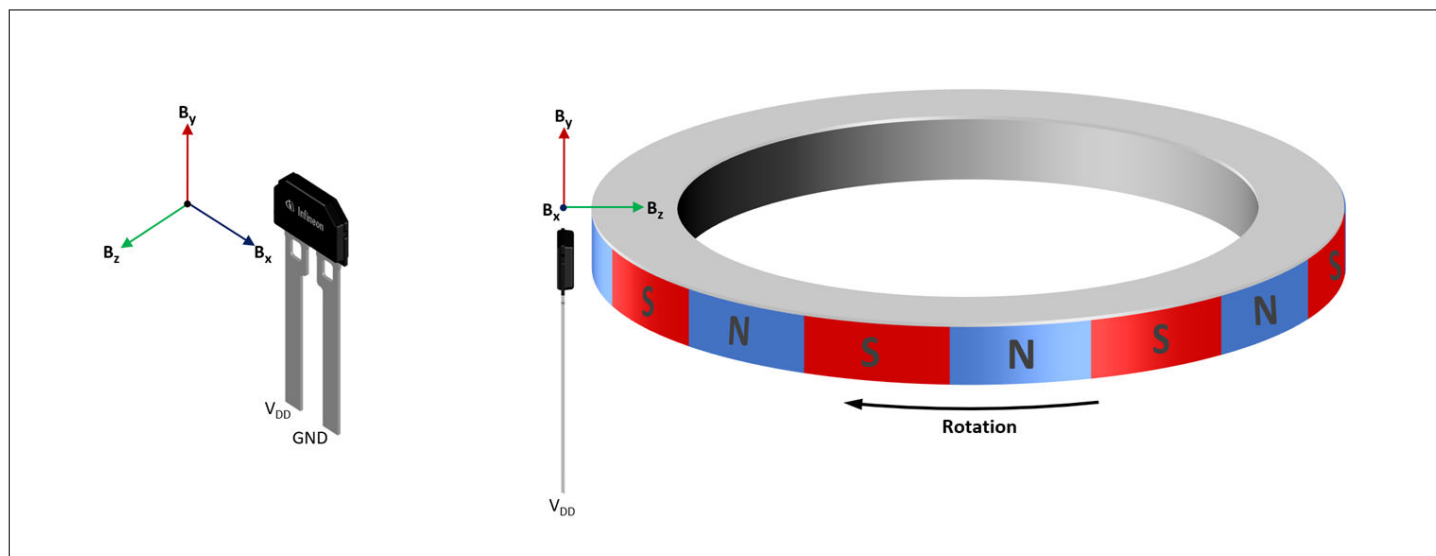


Figure 3 TLE55493iC coordinate system and typical mounting position in magnetic encoder applications

Note: $Y = 0 \text{ mm}$ refers to the $B_y = 0 \text{ mT}$ line of the magnetized stripe.

4.1 Undervoltage and power-on

The sensor implements an undervoltage comparator capable to trigger a reset signal when the supply voltage (i.e. V_{DD}) drops below the defined reset threshold V_{DD_RESET} .

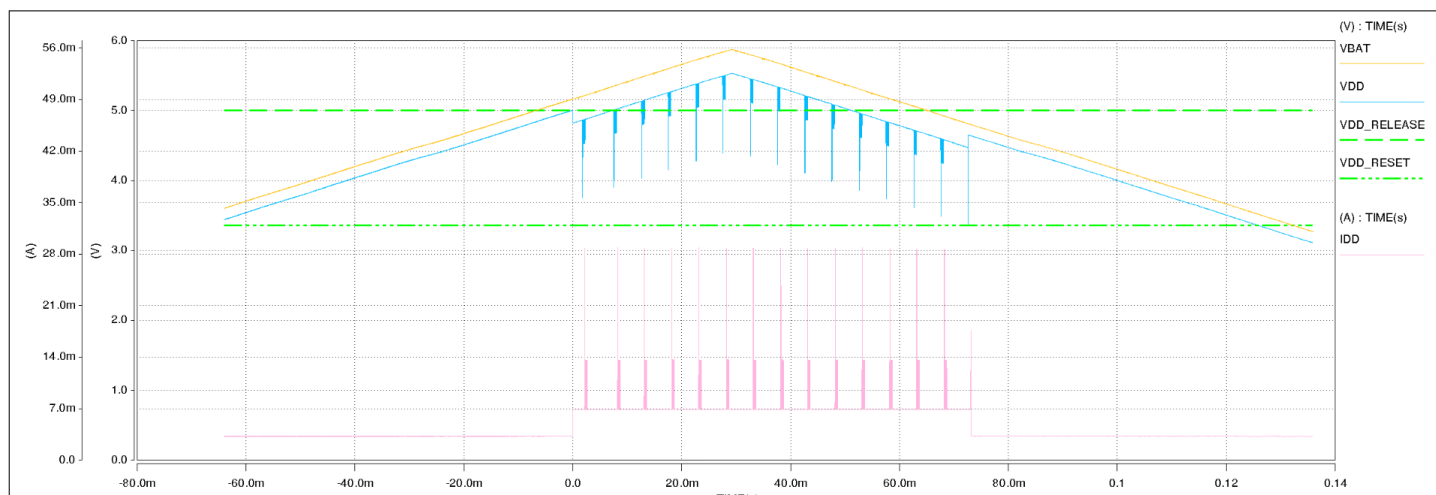


Figure 4 Undervoltage behavior

If V_{DD} drops below V_{DD_RESET} , then the sensor goes into reset state and reduces its current consumption down to I_{ERR} . If V_{DD} rises above V_{DD_MIN} level, then the sensor resumes the defined behavior within its power-on time.

$$V_{DD_RELEASE} = V_{DD_RESET} + V_{DD_HYST}$$

During the startup phase the current reaches the value of I_{ERR} before V_{DD} achieves $V_{DD_RELEASE}$.

4 Functional description

The initial current level for uncalibrated mode (I_{LOW}) is reached within the sensor power-on time and it fulfills the specified current limits as long as V_{DD} is above $V_{DD_RELEASE}$.

4.2 Output protocol (AK)

The AK output protocol is compliant to the document: "Requirement Specifications for Standardized Interface for Wheel Speed Sensors with Additional Information "AK-Protokoll" " Version: 4.0 13.02.2008 of Daimler AG, unless otherwise stated.

4.2.1 AK bits definition

Bits 0 - 8 are designated as data protocol and their purpose is to transfer additional information to the ECU. Bit #0 is used as an indication for air gap reserve (LR). Bit #1 (M), bit #3 (GDR), bit #4 (DR) and bit #8 (P) encode information regarding sensor calibration, validity of direction, direction of rotation and parity, respectively. Bit #2 (HR) is used to mark the high resolution protocols, while bits #5, #6, #7 (LM0, LM1, LM2) encode information regarding the amplitude of the magnetic field. Zero-crossing protocols and high resolution protocols provide a first current pulse at I_{HIGH} level, while standstill protocols provide a first current pulse at I_{MID} level.

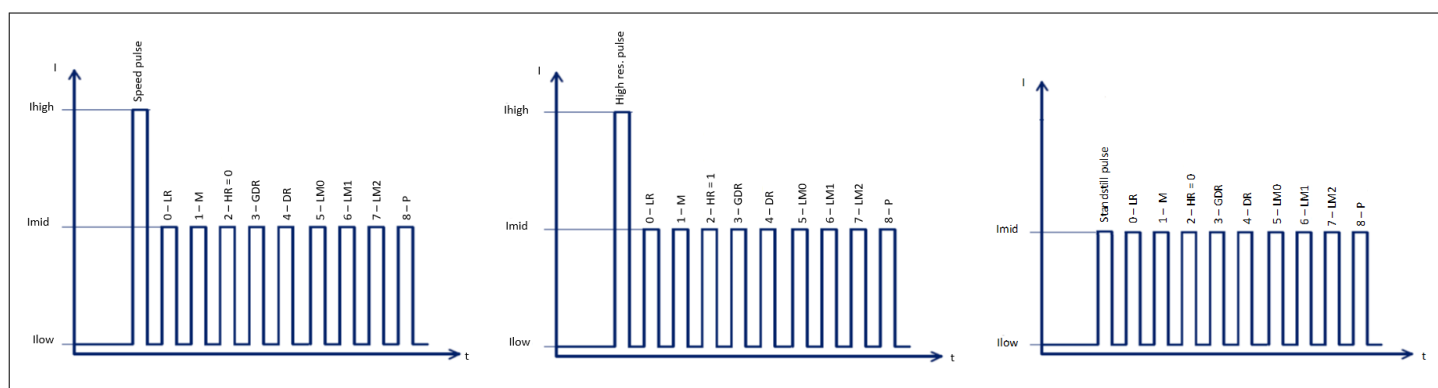


Figure 5 TLE55493iC-LR-4H bits encoding

The AK bits are encoded according to the following table.

Table 4 Bits Definition (AK-LR-4H)

| Bit | Content | Abbrv. | Value after power-on | Coding | Comments |
|-----|--------------------|--------|----------------------|---|--|
| 0 | Airgap reserve | LR | '0' | '1' if airgap reserve is reached | if $dB_{LIMIT} < dB_{SP} < 2 \cdot dB_{LIMIT}$ or $dB_{LIMIT,DIR} < dB_{DIR} < 2 \cdot dB_{LIMIT,DIR}$ |
| 1 | Modus bit | M | '1' | '1' in uncalibrated mode '0' in calibrated mode | if $M='0'$, then LM info is valid |
| 2 | High resolution | HR | acc. magnetic phase | '1' for high resolution protocols '0' for zero crossings protocols | - |
| 3 | Direction validity | GDR | '1' | '1' if direction of rotation is valid | - |
| 4 | Direction | DR | acc. wheel movement | '0' if direction of rotation is positive | - |
| 5 | LM bit | LM0 | '0' | See LM bits encoding | LM might also be updated while $M='1'$ |
| 6 | | LM1 | '0' | | |

(table continues...)

Table 4 (continued) **Bits Definition (AK-LR-4H)**

| Bit | Content | Abbrev. | Value after power-on | Coding | Comments |
|-----|---------|---------|----------------------|--|----------|
| 7 | | LM2 | '0' | | |
| 8 | Parity | P | Parity | '1' if parity including parity bit is even | - |

4.2.1.1 LM bits encoding

The measured speed signal amplitude value is transmitted in the AK protocol using the LM bits. There is no hysteresis implemented for the calculation of the LM bits values. After power on the default value for LM is '000'. The speed signal amplitude is measured both in uncalibrated and calibrated mode. Nevertheless, LM values are valid only in calibrated mode, which is flagged by the M bit.

The relation between differential magnetic field and LM bits value is given in the following table.

Table 5 **LM bits encoding**

| LM decimal | LM binary | Level in relation to dB_{LIMIT} |
|------------|-----------|-----------------------------------|
| 0 | 000 | ≤ 2 |
| 1 | 001 | > 2 |
| 2 | 010 | > 4 |
| 3 | 011 | > 8 |
| 4 | 100 | > 16 |
| 5 | 101 | > 32 |
| 6 | 110 | > 64 |
| 7 | 111 | > 256 |

4.2.2 Bit stump suppression

The suppression of bit stumps in the Wheel Speed Sensor is required, so that the combination of sensors and ECUs from different manufacturers is as robust as possible. In this case, the sensor output is always completely shifted by a constant bit time when a new protocol start occurs. This is equivalent to a time output offset. The suppression of bit stumps is active in all speed ranges and in all operating states of the sensor.

5 ESD and EMC characteristics

EMC verification is performed based on standardized test methods under nominal environmental and operational conditions within typical application circuits, which are in detail documented within the test report. The procedure is consistent with Generic IC EMC Test Specification (BISS v2.1) and according ISO 26262 Part 5, Clause 10. EMC test pass/fail criteria are derived from product specifications, application requirements and top-level safety requirements. A defined relevant subset of the functional behavior and parameters of an IC is monitored during EMC tests. Observed deviations from the intended IC behavior are part of the test documentation. EMC requirements are not subject to production test and are verified by design and/or characterization based on typical samples from a typical lot. The characterization results will be assessed by technical experts and shared with the customer as a reference. Given the dependency of EMC performance on the integration on system level, it is the system integrators responsibility to ensure performance on system level.

Table 6 ESD characteristics

| Parameter | Symbol | Values | | | Unit | Note or condition |
|-----------------|-----------|--------|------|------|------|---------------------------------------|
| | | Min. | Typ. | Max. | | |
| ESD HBM Voltage | V_{HBM} | -12 | - | 12 | kV | Method AEC-Q100 -002 C=100pF, R=1500Ω |

6 Package

The product is RoHS compliant (restriction of hazardous substances directive).

By following the application note "Recommendation for handling and assembly of Infineon PG-SSO Sensor Packages", the sensor terminals can be bent without causing incipient cracks influencing the sensor element function.

Please refer to your key account team or regional sales if you need further information.

Table 7 Package parameters

| Parameter | Material |
|--------------|---------------------------|
| Lead Frame | CuCrSiTi (K75 UNS:C18070) |
| Lead Plating | Sn |

The product is delivered in blister packing.

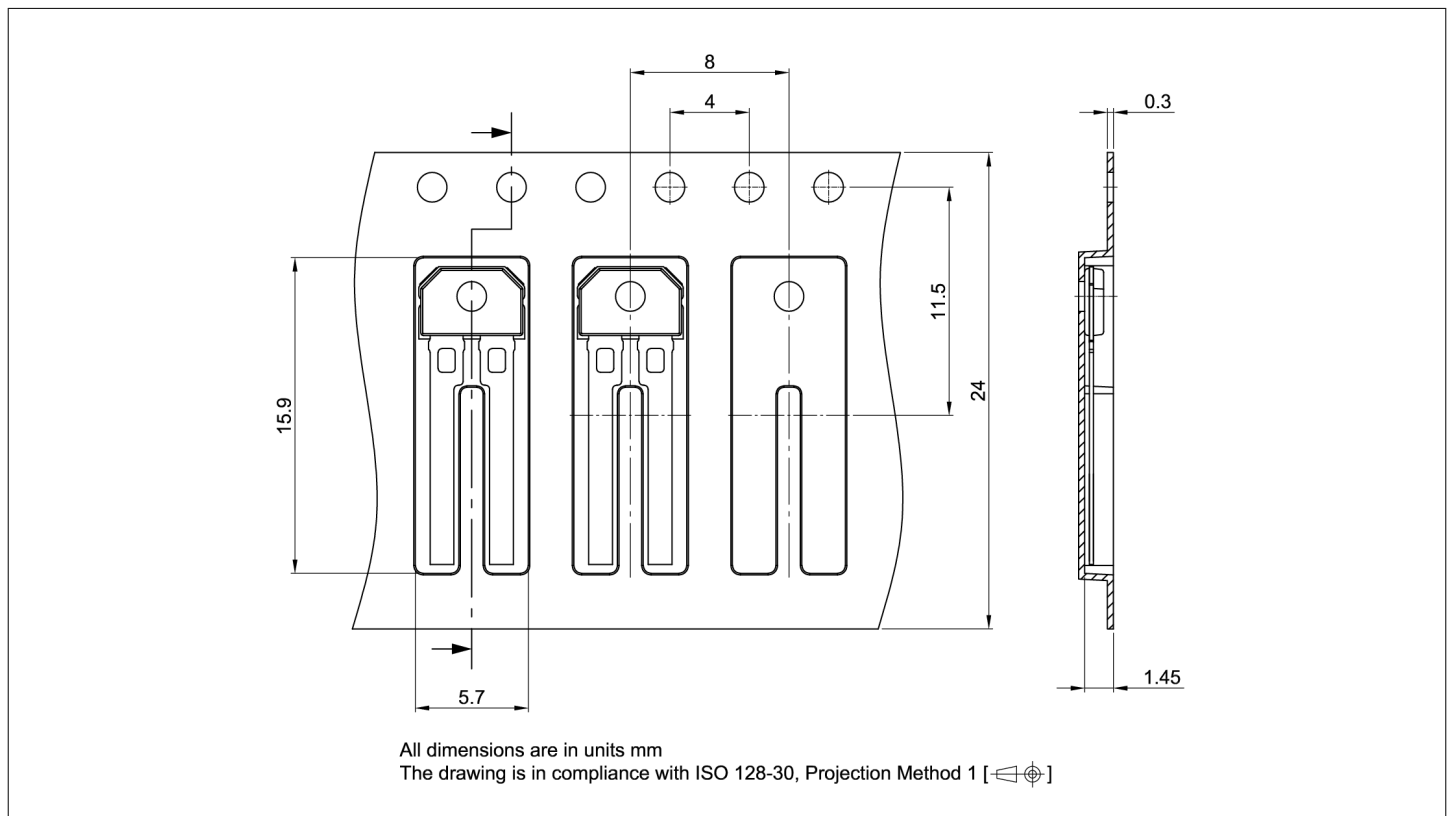


Figure 6 Packing dimensions of PG-SSO-2-51 in blister packing

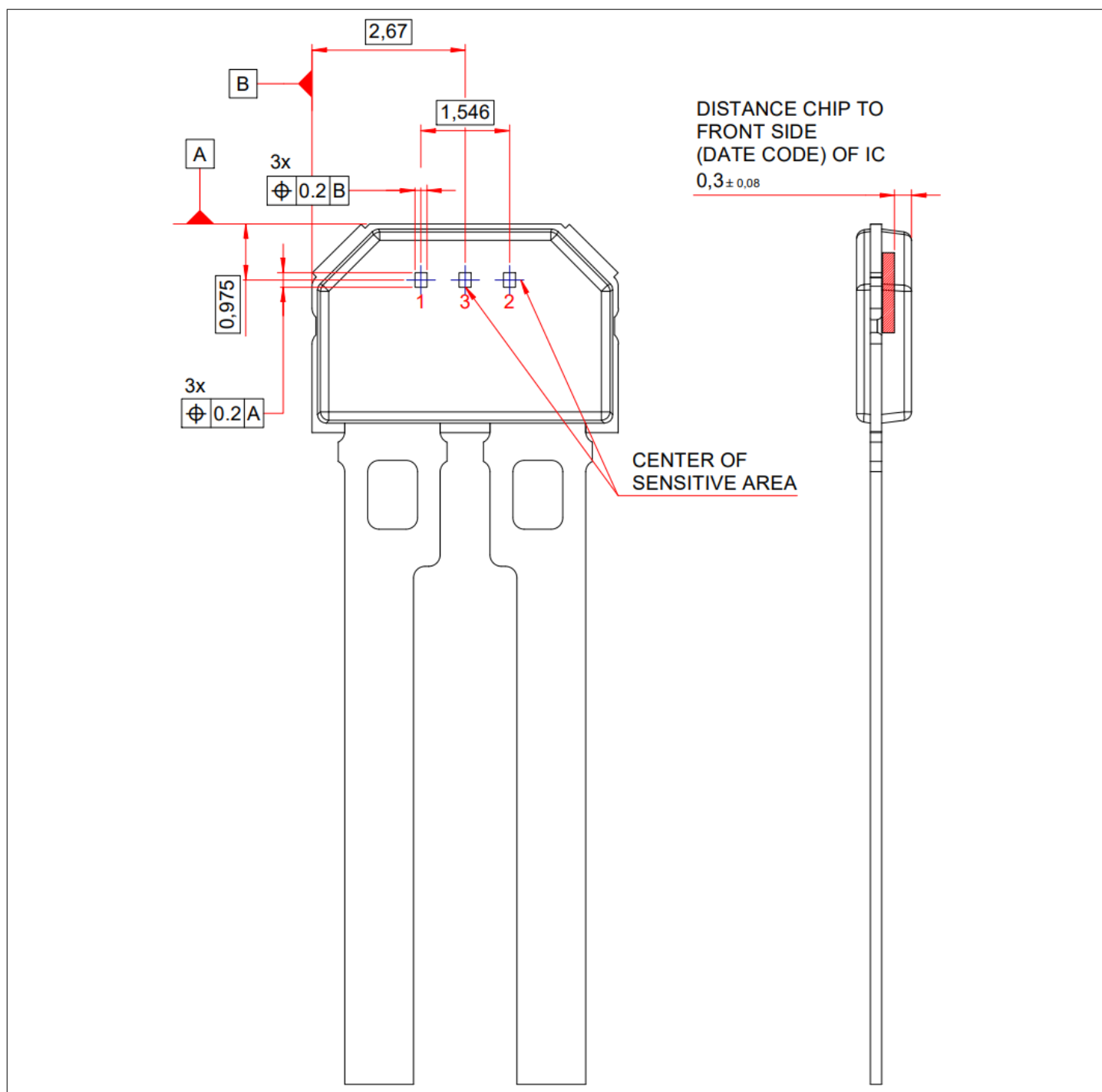


Figure 7 PG-SSO-2-51 package outline - sensing elements position details

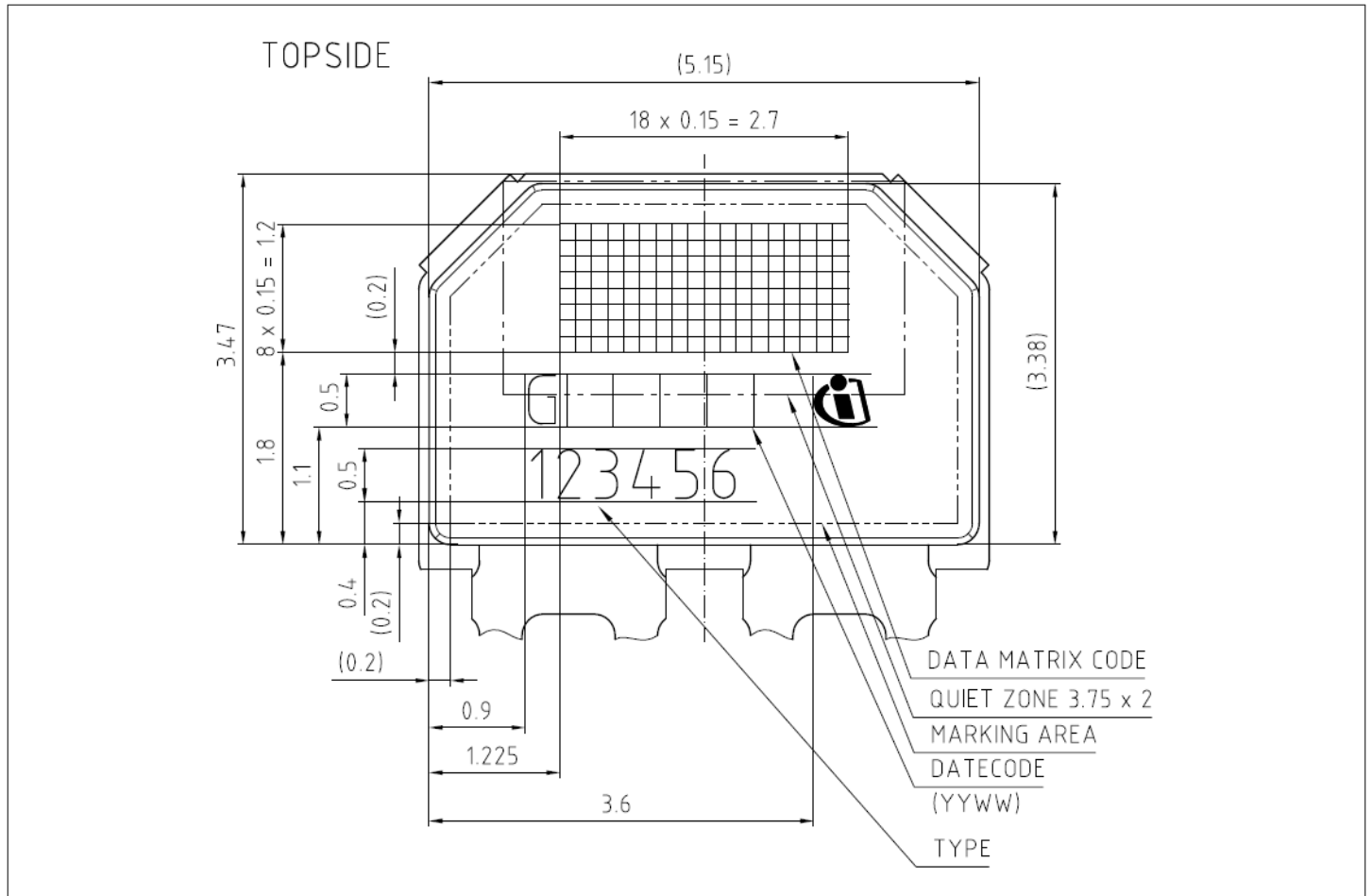


Figure 8 PG-SSO-2-51 marking

7 Revision history

| Date | Version | Change Description |
|-------------|----------------|--|
| 2025-05-09 | 1.00 | Initial release |
| 2026-01-12 | 1.01 | Classification set to "public"; Editorial changes |

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Edition 2026-01-12

Published by

Infineon Technologies AG

81726 Munich, Germany

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Document reference

IFX-Z8F80792245

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